

March 2013

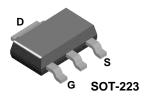
FQT13N06L N-Channel QFET® MOSFET 60 V, 2.8 A, 140 m Ω

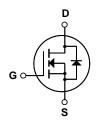
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 2.8 A, 60 V, $R_{DS(on)}$ =140 m $\Omega(Max.)$ @ V_{GS} =10 V, I_D =1.4 A
- Low Gate Charge (Typ. 4.8 nC)
- Low Crss (Typ. 17 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQT13N06L	Unit	
V _{DSS}	Drain-Source Voltage		60	V	
I _D	Drain Current - Continuous (T _C = 25°C)		2.8	А	
	- Continuous (T _C = 70°C)		2.24	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	11.2	А	
V_{GSS}	Gate-Source Voltage		± 20	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	85	mJ	
I _{AR}	Avalanche Current (Note 1		2.8	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.21	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		7.0	V/ns	
P_{D}	Power Dissipation (T _C = 25°C)		2.1	W	
	- Derate above 25°C		0.017	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	
٠.			300		

Thermal Characteristics

Symbol	Parameter	Тур	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		60	°C/W

^{*} When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	i	Min	Тур	Max	Unit
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced	to 25°C		0.05		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V				1	μА
		V _{DS} = 48 V, T _C = 125°C				10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Cha	racteristics		"		1		
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		1.0		2.5	V
R _{DS(on)}	Static Drain-Source	$V_{GS} = 10 \text{ V}, I_D = 1.4 \text{ A}$			0.088	0.11	
. (DS(on)	On-Resistance	$V_{GS} = 5 \text{ V}, I_D = 1.4 \text{ A}$			0.110	0.14	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 25 V, I _D = 1.4 A	(Note 4)		4.1		S
Dynam C _{iss}	ic Characteristics Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,			270	350	pF
C _{oss}	Output Capacitance	f = 1.0 MHz			95	125	pF
C _{rss}	Reverse Transfer Capacitance				17	23	pF
Switchi	ing Characteristics						
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, I_{D} = 6.8 \text{ A},$ $R_{G} = 25 \Omega$			8	25	ns
t _r	Turn-On Rise Time				90	190	ns
t _{d(off)}	Turn-Off Delay Time				20	50	ns
t _f	Turn-Off Fall Time		(Note 4, 5)		40	90	ns
Qg	Total Gate Charge	V _{DS} = 48 V, I _D = 13.6 A,			4.8	6.4	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V (Note 4, 5)			1.6		nC
Q _{gd}	Gate-Drain Charge				2.7		nC
Drain-S	Source Diode Characteristics a	nd Maximum Rating	S				
I _S	Maximum Continuous Drain-Source Diode Forward Current					2.8	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	Forward Current				11.2	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2.8 \text{ A}$				1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 13.6 \text{ A},$			45		ns
	i e e e e e e e e e e e e e e e e e e e	4	(Note 4)				

- Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 12.6mH, I_{AS} = 2.8A, V_{DD} = 25V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} \leq 13.6A, di/dt \leq 300A/μs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Typical Characteristics

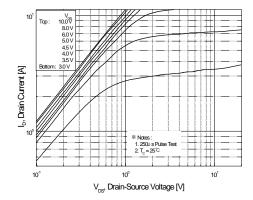


Figure 1. On-Region Characteristics

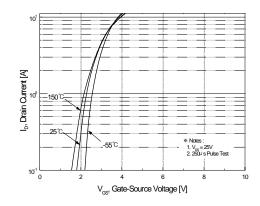


Figure 2. Transfer Characteristics

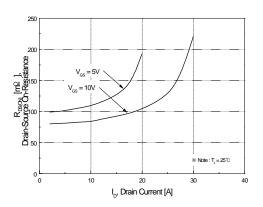


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

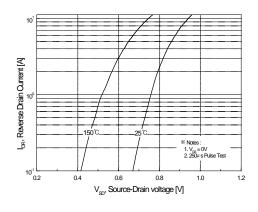


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

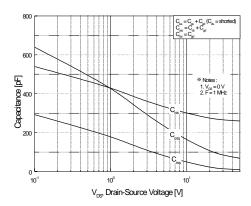


Figure 5. Capacitance Characteristics

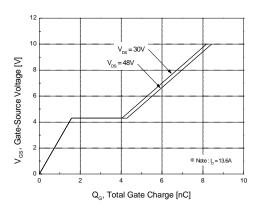
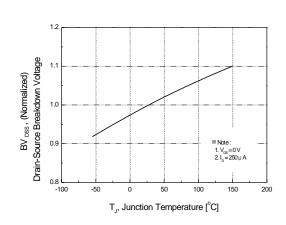


Figure 6. Gate Charge Characteristics



Typical Characteristics (Continued)

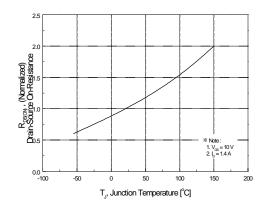
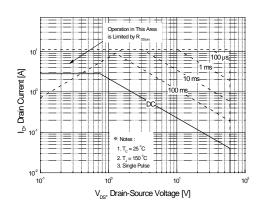


Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



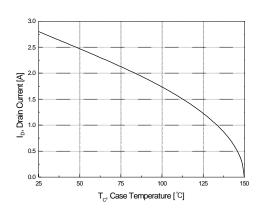


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

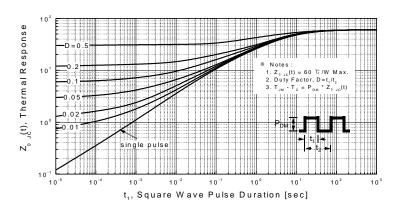
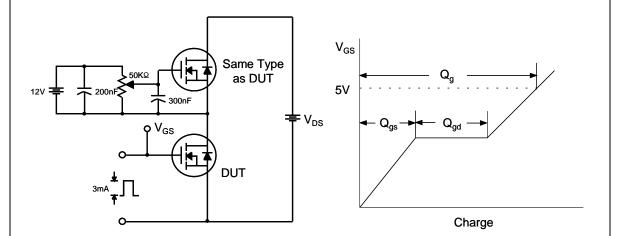
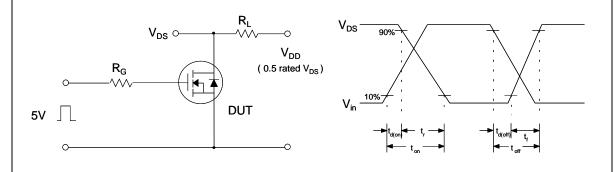


Figure 11. Transient Thermal Response Curve

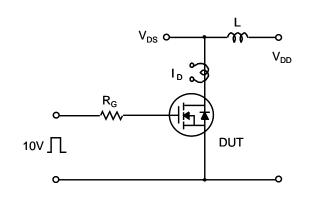
Gate Charge Test Circuit & Waveform

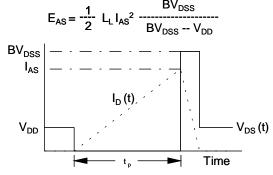


Resistive Switching Test Circuit & Waveforms

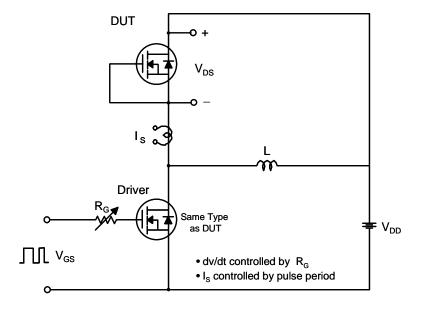


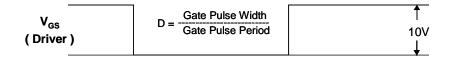
Unclamped Inductive Switching Test Circuit & Waveform

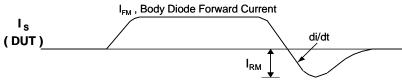




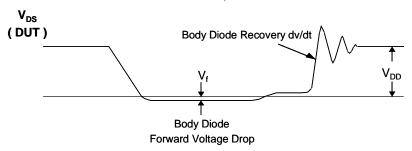
Peak Diode Recovery dv/dt Test Circuit & Waveform

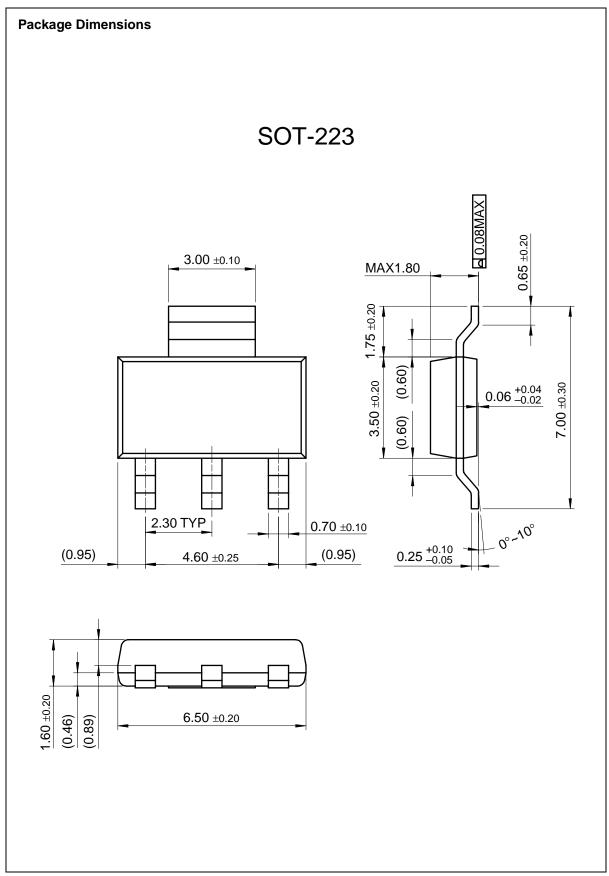






Body Diode Reverse Current









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